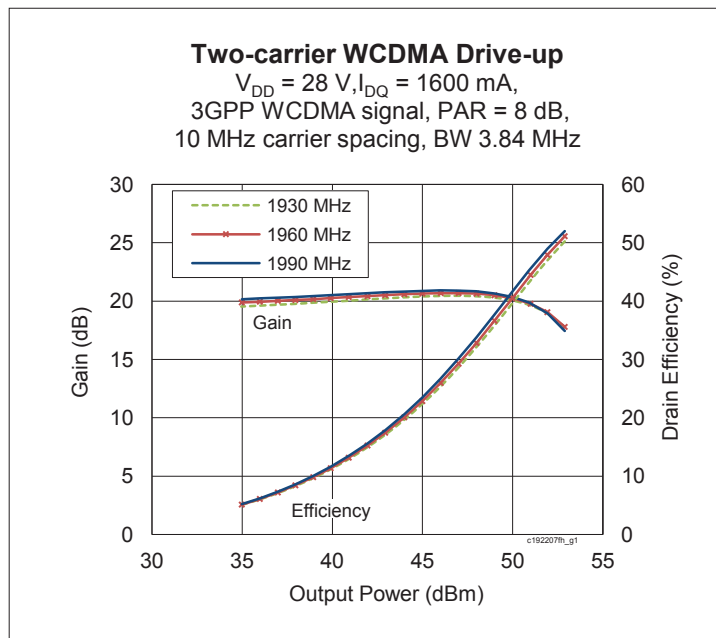


Thermally-Enhanced High Power RF LDMOS FET 220 W, 28 V, 1805 – 1990 MHz

Description

The PXFC192207FH is a 220-watt LDMOS FET intended for use in multi-standard cellular power amplifier applications in the 1805 to 1990 MHz frequency band. Features include input and output matching, high gain and thermally-enhanced package with earless flanges. Manufactured with Infineon's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.

PXFC192207FH
Package H-37288G-4/2



Features

- Broadband input and output matching
- Typical Pulsed CW performance, 1990 MHz, 28 V, 16 μs pulse width, 10 % duty cycle, class AB
 - Output power at $P_{1dB} = 220\text{ W}$
 - Efficiency = 55%
 - Gain = 20 dB
- Typical single-carrier WCDMA performance, 1990 MHz, 28 V, 9.9 dB PAR @ 0.01% CCDF
 - Output power = 50 W
 - Efficiency = 29%
 - Gain = 20 dB
 - ACPR = -34 dBc @ 5 MHz
- Capable of handling 10:1 VSWR @ 28 V, 220 W (CW) output power
- Integrated ESD protection : Human Body Model, Class 1C (per JESD22-A114)
- Low thermal resistance
- Pb-free and RoHS compliant

RF Characteristics

Two-carrier WCDMA Specifications (tested in Infineon production test fixture)

$V_{DD} = 28\text{ V}, I_{DQ} = 1600\text{ mA}, P_{OUT} = 50\text{ W avg.}, f_1 = 1980\text{ MHz}, f_2 = 1990\text{ MHz}$, 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 8 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Linear Gain	G_{ps}	19	20.5	—	dB
Drain Efficiency	η_D	29	32	—	%
Intermodulation Distortion	IMD	—	-32.5	-29	dBc

All published data at $T_{CASE} = 25^\circ\text{C}$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

DC Characteristics

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	—	—	1	μA
	$V_{DS} = 63\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	—	—	10	μA
On-State Resistance	$V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.03	—	Ω
Operating Gate Voltage	$V_{DS} = 28\text{ V}, I_{DQ} = 1.6\text{ A}$	V_{GS}	2.3	2.6	2.9	V
Gate Leakage Current	$V_{GS} = 10\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	—	—	1	μA

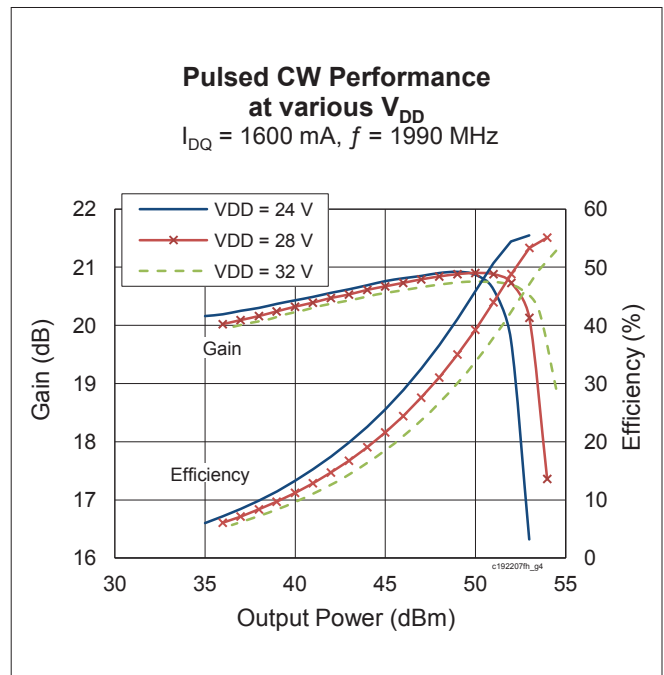
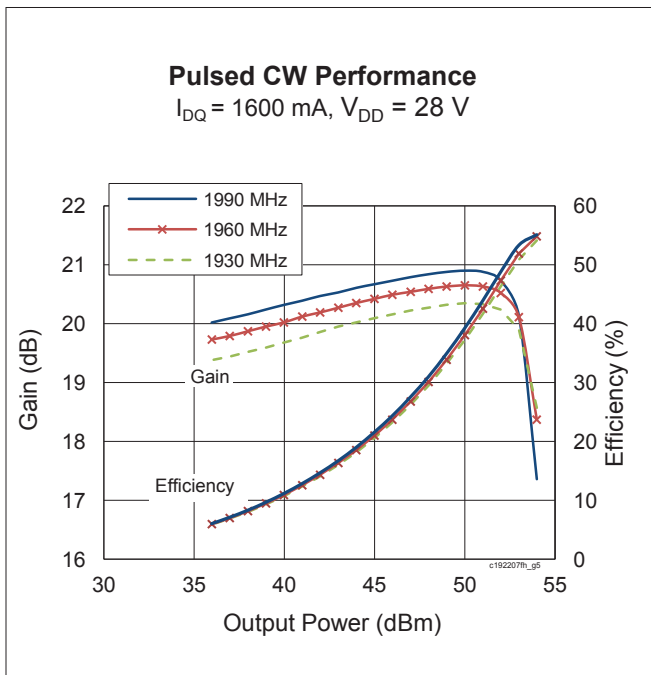
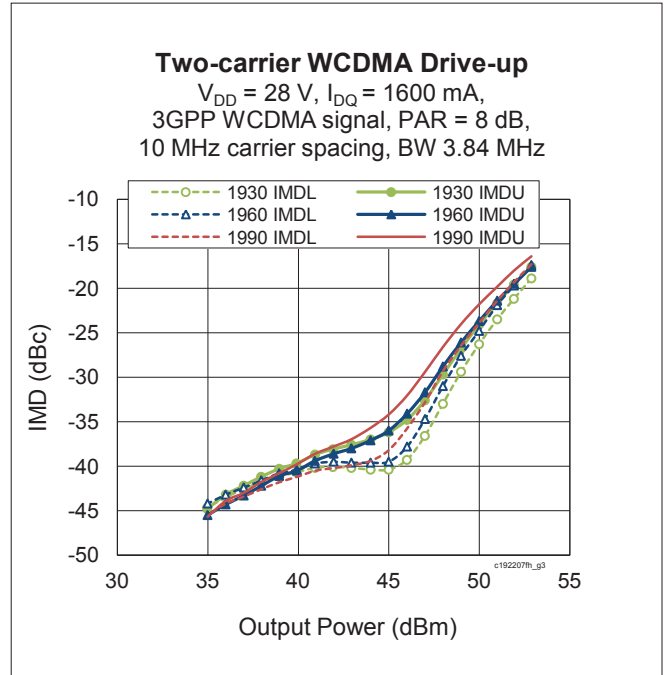
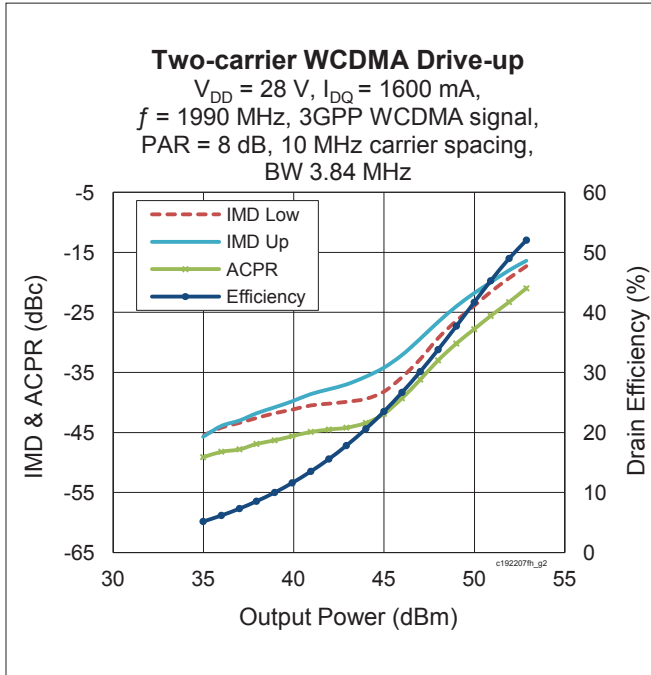
Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	V
Gate-Source Voltage	V_{GS}	-6 to +10	V
Operating Voltage	V_{DD}	0 to +32	V
Junction Temperature	T_J	225	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150	$^{\circ}\text{C}$
Thermal Resistance ($T_{CASE} = 70^{\circ}\text{C}, 200\text{ W CW}$)	$R_{\theta JC}$	0.28	$^{\circ}\text{C/W}$

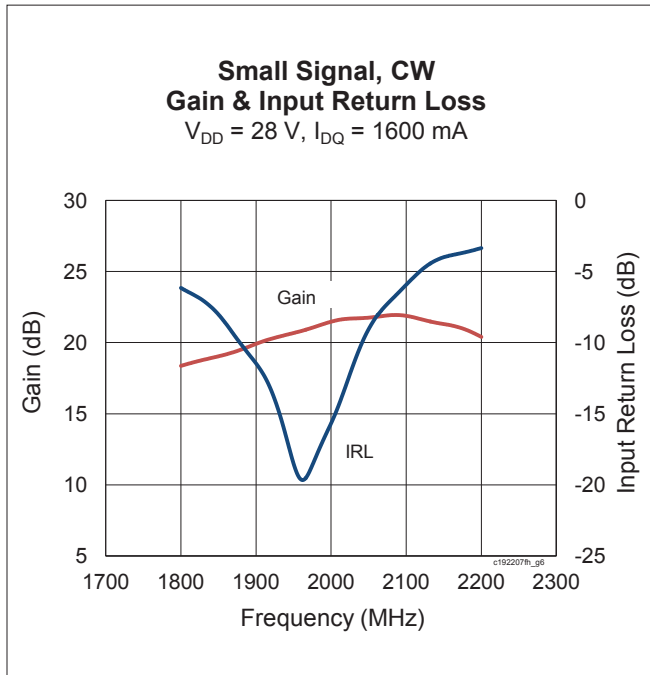
Ordering Information

Type and Version	Order Code	Package Description	Shipping
PXFC192207FH V3 R0	PXFC192207FHV3R0XTMA1	H-37288G-4/2, earless flange	Tape & Reel, 50 pcs
PXFC192207FH V3 R250	PXFC192207FHV3R250XTMA1	H-37288G-4/2, earless flange	Tape & Reel, 250 pcs

Typical Performance (data taken in a production test fixture)

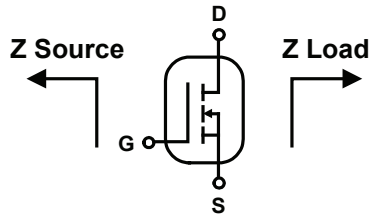


Typical Performance (cont.)



See next page for broadband circuit impedance

Broadband Circuit Impedance



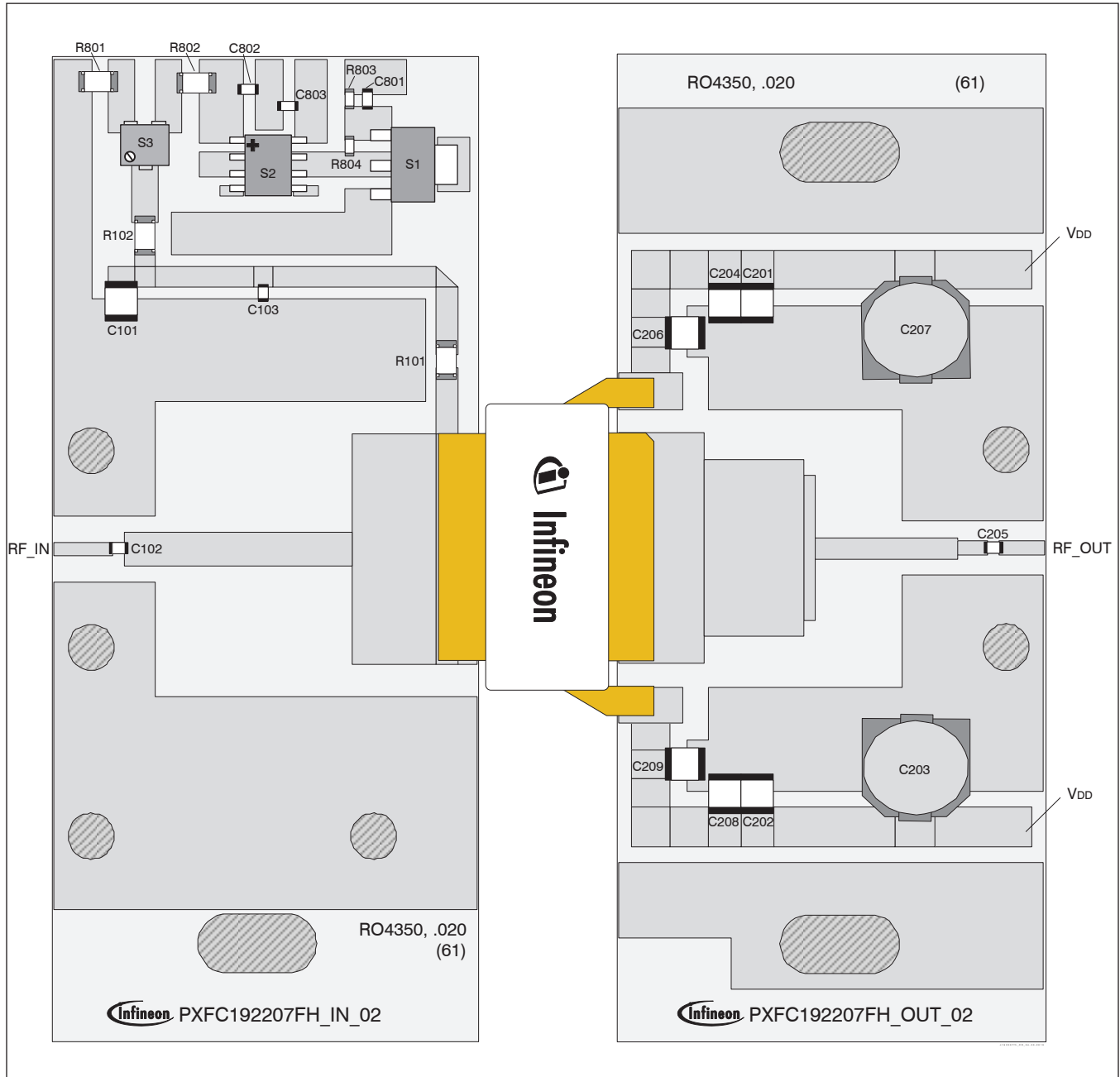
Freq [MHz]	Z Source Ω		Z Load Ω	
	R	jX	R	jX
1930	3.12	-4.70	1.15	-2.80
1960	3.11	-4.62	1.14	-2.69
1990	3.10	-4.55	1.13	-2.58

Load Pull Performance

Each Side Load Pull Performance – Pulsed CW signal: 16 μ s, 10% duty cycle, 28 V, 1100 mA

Freq [MHz]	Zs [Ω]	P _{1dB}									
		Max Output Power					Max PAE				
		ZI [Ω]	Gain [dB]	P _{OUT} [dBm]	P _{OUT} [W]	PAE [%]	ZI [Ω]	Gain [dB]	P _{OUT} [dBm]	P _{OUT} [W]	PAE [%]
1805	2.1-j3.4	0.7-j2.4	16.8	55.1	324	54.1	1.6-j1.9	19.3	53.4	219	65.7
1880	2.1-j3.3	0.7-j2.5	17.6	55.0	316	54.4	1.6-j1.9	20.3	53.0	200	65.0
1930	1.9-j3.7	0.8-j2.6	17.8	54.7	295	50.0	1.4-j2.0	20.6	53.0	200	62.8
1990	3.8-j4.1	0.7-j2.8	18.4	54.6	288	50.8	1.4-j2.1	21	52.8	191	61.7

Reference Circuit , 1930 – 1990 MHz



Reference circuit assembly diagram (not to scale)*

Reference Circuit (cont.)

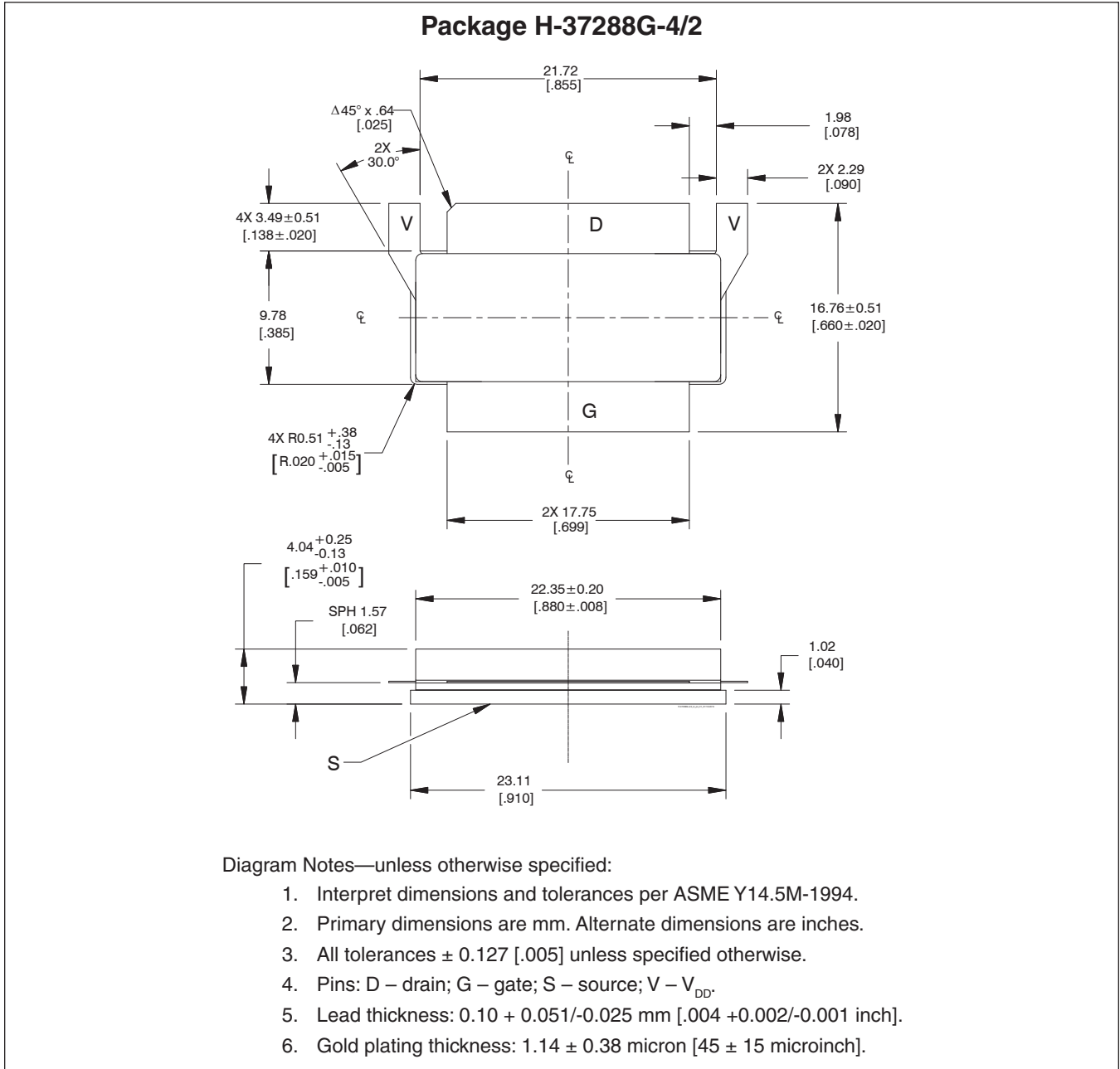
Reference Circuit Assembly

DUT	PXFC192207FH
Test Fixture Part No.	LTN/PXFC192207FH V3
PCB	Rogers 4350, 0.508 mm [0.020"] thick, 2 oz. copper, $\epsilon_r = 3.66$, $f = 1930 - 1990$ MHz
Find Gerber files for this test fixture on the Infineon Web site at http://www.infineon.com/rfpower	

Components Information

Component	Description	Suggested Manufacturer	P/N
Input			
C101	Capacitor, 10 μ F	Taiyo Yuden	UMK325C7106MM-T
C102, C103	Capacitor, 33 pF	ATC	ATC100A330JW150XB
C801, C802, C803	Capacitor, 1000 pF	Panasonic Electronic Components	ECJ-1VB1H102K
R101, R102, R801	Resistor, 10 Ω	Panasonic Electronic Components	ERJ-8GEYJ100V
R802	Resistor, 100 Ω	Panasonic Electronic Components	ERJ-8GEYJ101V
R803	Resistor, 1300 Ω	Panasonic Electronic Components	ERJ-3GEYJ132V
R804	Resistor, 1200 Ω	Panasonic Electronic Components	ERJ-3GEYJ122V
S1	Transistor	Infineon Technologies	BCP56
S2	Voltage Regulator	Texas Instruments	LM78L05ACM
S3	Potentiometer, 2k Ω	Bourns Inc.	3224W-1-202E
Output			
C201, C202, C204, C206, C208, C209	Capacitor, 10 μ F	Taiyo Yuden	UMK325C7106MM-T
C203, C207	Capacitor, 220 μ F	Panasonic Electronic Components	EEE-FP1V221AP
C205	Capacitor, 33 pF	ATC	ATC100A330JW150XB

Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page <http://www.infineon.com/rfpower>

Revision History

Revision	Date	Data Sheet Type	Page	Subjects (major changes since last revision)
01	2013-02-04	Advance	All	Data Sheet reflects advance specification for product development
02	2013-04-29	Production	All	Data Sheet reflects released product specifications
03	2013-07-18	Production	All 1 2 7 8	Updated package from V1 to V2 for general release Updated package and revised efficiency in Two-carrier WCDMA specifications table Updated ordering information table Updated LTN version Updated package outline
04	2014-07-15	Production	All 1 2	Updated package from V2 to V3 for general release Updated Two-carrier WCDMA specifications table Revised junction temperature in Maximum Ratings table
04.1	2016-06-22	Production	2	Updated ordering information

We Listen to Your Comments

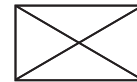
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